



Pb Free Product

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0208KA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

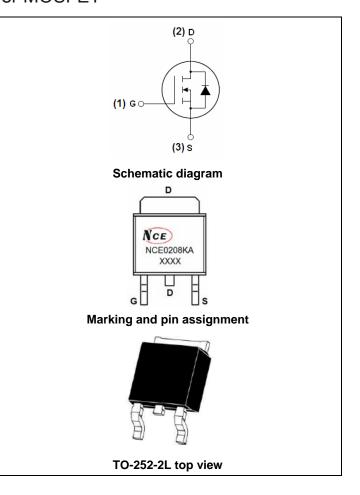
General Features

- V_{DS} =200V, I_D =8A $R_{DS(ON)}$ <300m Ω @ V_{GS} =10V (Typ: 260m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0208KA	NCE0208KA	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	200	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	8	Α
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	5.6	Α
Pulsed Drain Current	I _{DM}	20	Α
Maximum Power Dissipation	P _D	55	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	2.3	°C/W





Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA 2		215	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =200V, V_{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.7	2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =4.5A	-	260	300	mΩ
Forward Transconductance	g FS	V _{DS} =25V,I _D =4.5A	3	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ 05\/\/ 0\/		540		PF
Output Capacitance	C _{oss}	V_{DS} =25V, V_{GS} =0V, F=1.0MHz		90		PF
Reverse Transfer Capacitance	C _{rss}	r-1.0Winz		35		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS
Turn-on Rise Time	t _r	V_{DD} =100 V , I_{D} =4.5 A	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =5 Ω	-	20	-	nS
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg	\/ -160\/ -4.54	-	16	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =160V, I_{D} =4.5A,	-	3.4	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	5.1	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =8A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	8	Α

Notes:

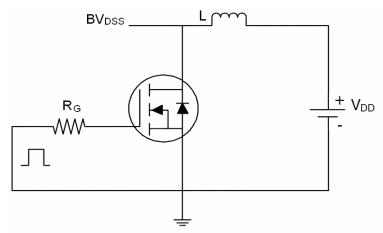
- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



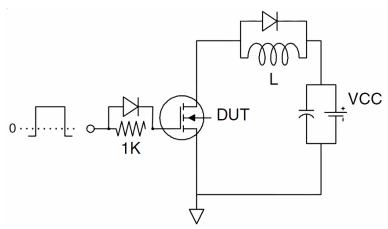
NCE0208KA

Test Circuit

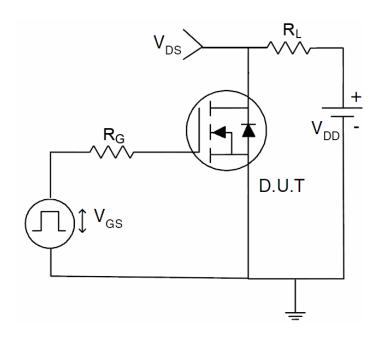
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit

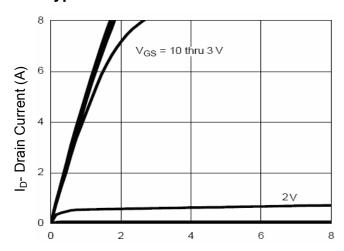


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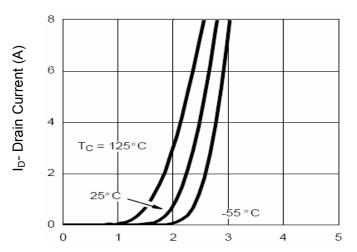


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Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V) **Figure 1 Output Characteristics**



Vgs Gate-Source Voltage (V) **Figure 2 Transfer Characteristics**

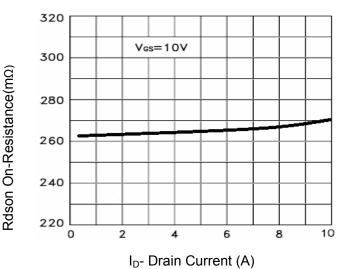


Figure 3 Rdson- Drain Current

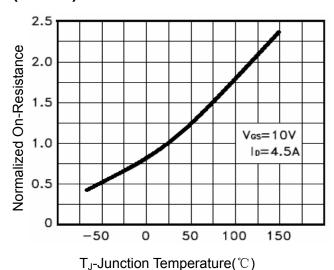


Figure 4 Rdson-JunctionTemperature

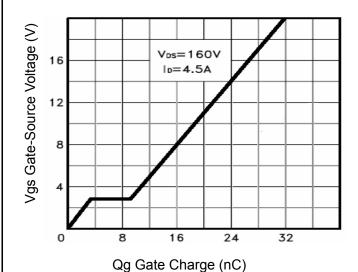


Figure 5 Gate Charge

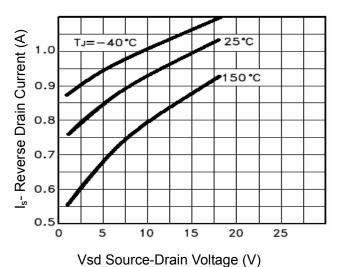
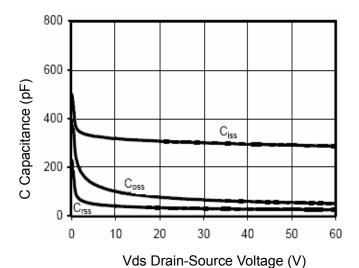


Figure 6 Source- Drain Diode Forward





T_J-Junction Temperature(°C)

Figure 9 BV_{DSS} vs Junction Temperature

(V) 10¹/₈ 10μs 10μs 10μs

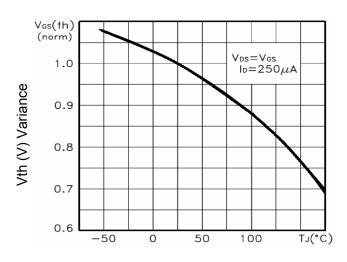
Figure 7 Capacitance vs Vds

Vds Drain-Source Voltage (V)

10

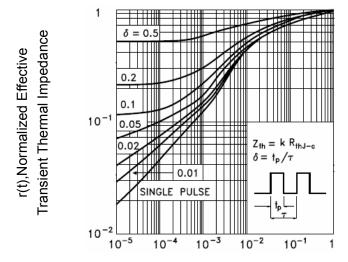
10⁰

Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 10 V_{GS(th)} vs Junction Temperature

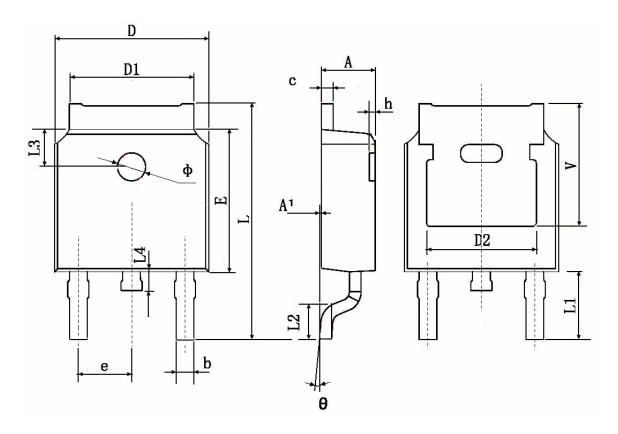


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483	TYP.	0.190 TYP.		
Е	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	1.600 TYP.		TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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